


**Table 1. Main characteristics**

Symbol	Value	Unit
$I_{T(rms)}$	4	A
$V_{DRM}, V_{RRM}$	600 to 800	V
$I_{GT}$	5 to 35	mA

**Table 2. Device summary**

Symbol <sup>(1)</sup>	Marking
T405-xxxB	see <a href="#">Table 11</a>
T405-xxxB-TR	
T405-xxxH	
T405-xxxT	
T410-xxxB	
T410-xxxB-TR	
T410-xxxH	
T410-xxxT	
T435-xxxB	
T435-xxxB-TR	
T435-xxxH	
T435-xxxT	

1. xxx = Voltage: 600 V, 700 V or 800 V (see [Table 10](#)).

## Features

- Three quadrants Triac
- 600 to 800 V  $V_{DRM}/V_{RRM}$

## Applications

- General purpose AC inductive loads
- Motor control circuits
- Small home appliances

## Description

Based on ST's Snubberless / logic level technology providing high commutation performances, the T4 series is suitable for use on AC inductive loads. They are recommended for applications using universal motors, electro valves, kitchen aid equipments, power tools, and dishwashers.

# 1 Characteristics

**Table 3. Absolute maximum ratings ( $T_j = 25\text{ °C}$  unless otherwise stated)**

Symbol	Parameter			Value	Unit
$I_{T(rms)}$	On-state rms current (full sine wave)	IPAK, DPAK, TO-220AB	$T_c = 110\text{ °C}$	4	A
$I_{TSM}$	Non repetitive surge peak on-state current (full cycle, $T_j$ initial = $25\text{ °C}$ )	F = 50 Hz	t = 20 ms	30	A
		F = 60 Hz	t = 16.7 ms	31	
$I^2t$	$I^2t$ value for fusing		$t_p = 10\text{ ms}$	5.1	$A^2s$
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \leq 100\text{ ns}$	F = 120 Hz	$T_j = 125\text{ °C}$	50	A/ $\mu s$
$I_{GM}$	Peak gate current	$t_p = 20\text{ }\mu s$	$T_j = 125\text{ °C}$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125\text{ °C}$	1	W
$T_{stg}$	Storage junction temperature range			- 40 to +150	$^{\circ}C$
$T_j$	Operating junction temperature range			- 40 to +125	

**Table 4. Electrical characteristics ( $T_j = 25\text{ °C}$ , unless otherwise stated)**

Symbol	Test conditions	Quadrant		Value			Unit
				T405	T410	T435	
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$ , $R_L = 30\text{ }\Omega$	I - II - III	Max.	5	10	35	mA
$V_{GT}$	$V_D = 12\text{ V}$ , $R_L = 30\text{ }\Omega$	I - II - III	Max.	1.3			V
$V_{GD}$	$V_D = V_{DRM}$ , $R_L = 3.3\text{ k}\Omega$ , $T_j = 125\text{ °C}$	I - II - III	Min.	0.2			V
$I_H^{(2)}$	$I_T = 100\text{ mA}$		Max.	10	15	35	mA
$I_L$	$I_G = 1.2 I_{GT}$	I - III	Max.	10	25	50	mA
		II	Max.	15	30	60	
dV/dt <sup>(2)</sup>	$V_D = 67\% V_{DRM}$ , gate open	$T_j = 125\text{ °C}$	Min.	20	40	400	V/ $\mu s$
(dI/dt) <sub>c</sub> <sup>(2)</sup>	(dV/dt) <sub>c</sub> = 0.1 V/ $\mu s$	$T_j = 125\text{ °C}$	Min.	1.8	2.7		A/ms
	(dV/dt) <sub>c</sub> = 10 V/ $\mu s$			0.9	2.0		
	(without snubber)					2.5	

1. Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max.
2. For both polarities of A2 referenced to A1

Table 5. Static characteristics

Symbol	Test conditions			Value	Unit
$V_{TM}^{(1)}$	$I_{TM} = 5.5 \text{ A}$ , $t_p = 380 \text{ }\mu\text{s}$	$T_j = 25 \text{ }^\circ\text{C}$	Max.	1.56	V
$V_{t0}^{(1)}$	Threshold voltage	$T_j = 125 \text{ }^\circ\text{C}$	Max.	0.89	V
$R_d^{(1)}$	Dynamic resistance	$T_j = 125 \text{ }^\circ\text{C}$	Max.	120	m $\Omega$
$I_{DRM}$ $I_{RRM}$	$V_{DRM} = V_{RRM}$	$T_j = 25 \text{ }^\circ\text{C}$	Max.	5	$\mu\text{A}$
		$T_j = 125 \text{ }^\circ\text{C}$		1	mA

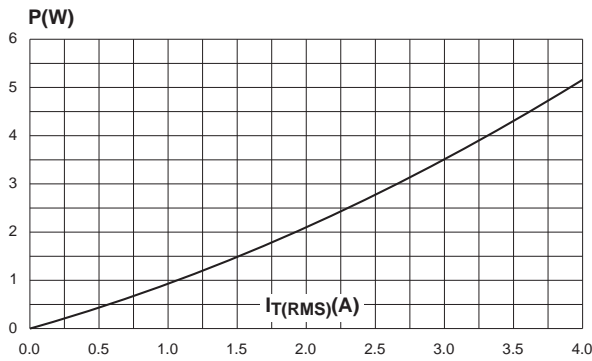
1. For both polarities of A2 referenced to A1

Table 6. Thermal resistance

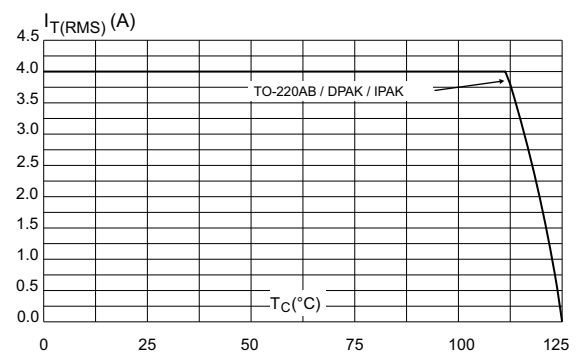
Symbol	Parameter		Value	Unit	
$R_{th(j-c)}$	Junction to case (AC)		IPAK, DPAK, TO-220AB	2.6	$^\circ\text{C/W}$
$R_{th(j-a)}$	Junction to ambient	$S^{(1)} = 0.5 \text{ cm}^2$	DPAK	70	$^\circ\text{C/W}$
	Junction to ambient		TO-220AB	60	$^\circ\text{C/W}$
				IPAK	100

1. S = Copper surface under tab.

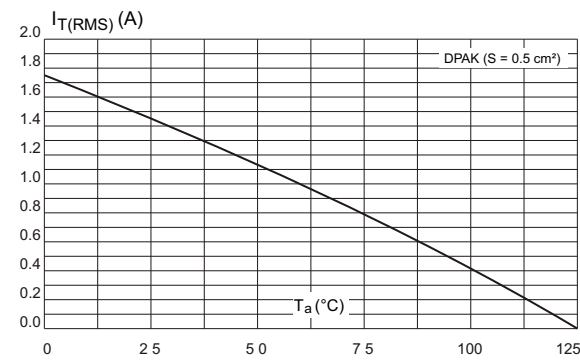
**Figure 1. Maximum power dissipation versus RMS on-state current (full cycle)**



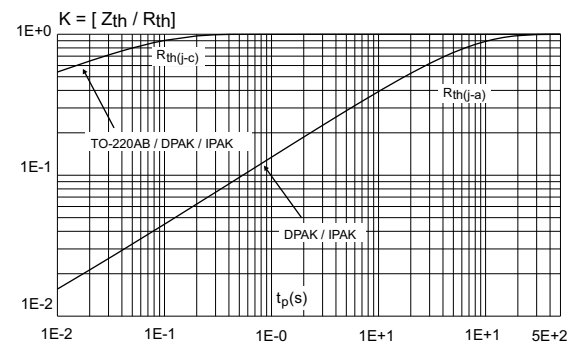
**Figure 2. RMS on-state current versus case temperature (full cycle)**



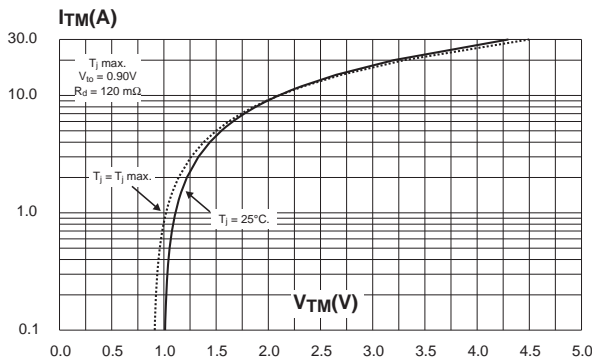
**Figure 3. RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35µm) (full cycle)**



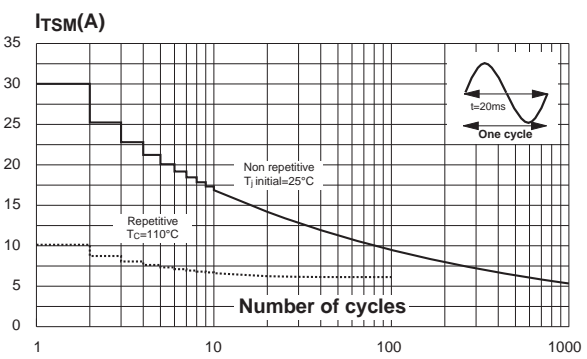
**Figure 4. Relative variation of thermal impedance versus pulse duration**



**Figure 5. On-state characteristics (maximum values)**



**Figure 6. Surge peak on-state current versus number of cycles**



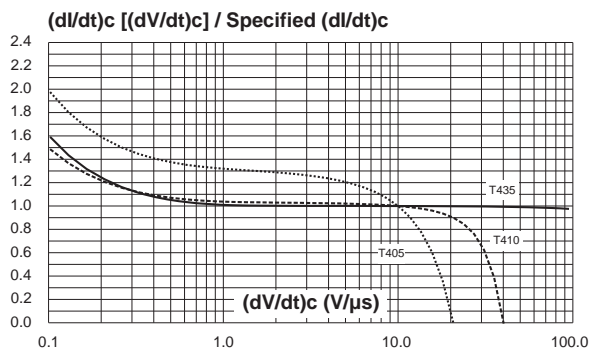
**Figure 7. Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms**



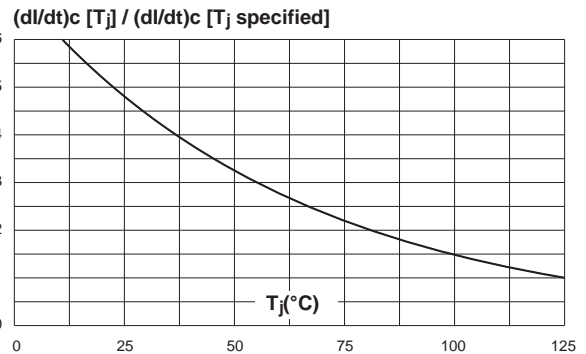
**Figure 8. Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)**



**Figure 9. Relative variation of critical rate of decrease of main current versus  $(dV/dt)_c$  (typical values)**



**Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature**



**Figure 11. DPAK thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35  $\mu$ m)**



## 2 Package information

- Molding epoxy meets UL94, V0 and is halogen free
- Lead-free package
- Recommended torque: 0.4 to 0.6 N·m for TO-220AB

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 2.1 DPAK package information

Figure 12. DPAK package outline



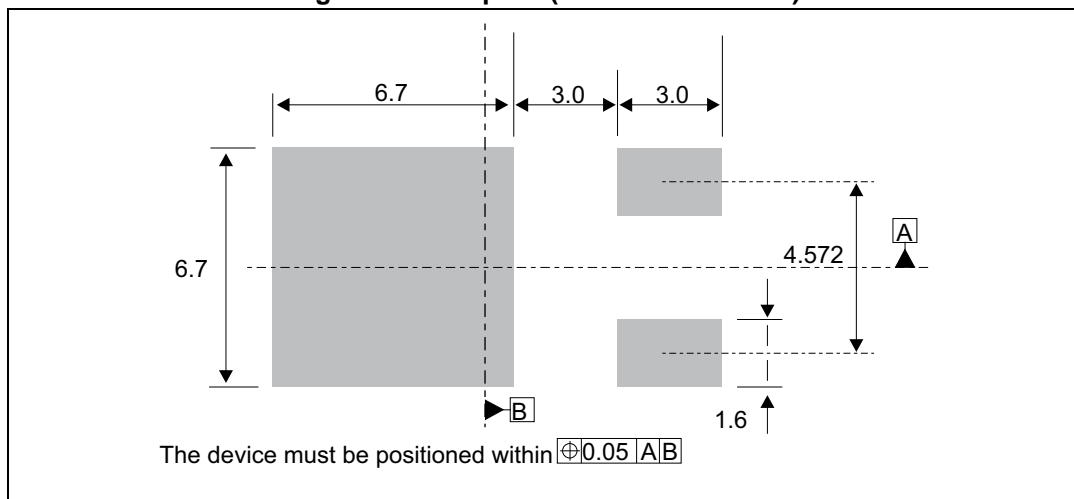
*Note:* This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 7. DPAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.18		2.40	0.086		0.0944
A1	0.9		1.10	0.035		0.0433
A2	0.03		0.23	0.0011		0.0090
b	0.64		0.90	0.0251		0.0354
b4	4.95		5.46	0.1948		0.2149
c	0.46		0.61	0.0181		0.0240
c2	0.46		0.60	0.0181		0.0236
D	5.97		6.22	0.2350		0.2448
D1	4.95			0.1948		
E	6.35		6.73	0.2500		0.2649
E1	4.32			0.1700		
e		2.286			0.09	
e1		4.572			0.18	
H	9.35		10.40	0.3681		0.4094
L	1.0		1.78	0.039		0.0700
L2			1.27			0.0500
L4	0.6		1.02	0.023		0.0401
V2	-8°		+8°	-8°		+8°

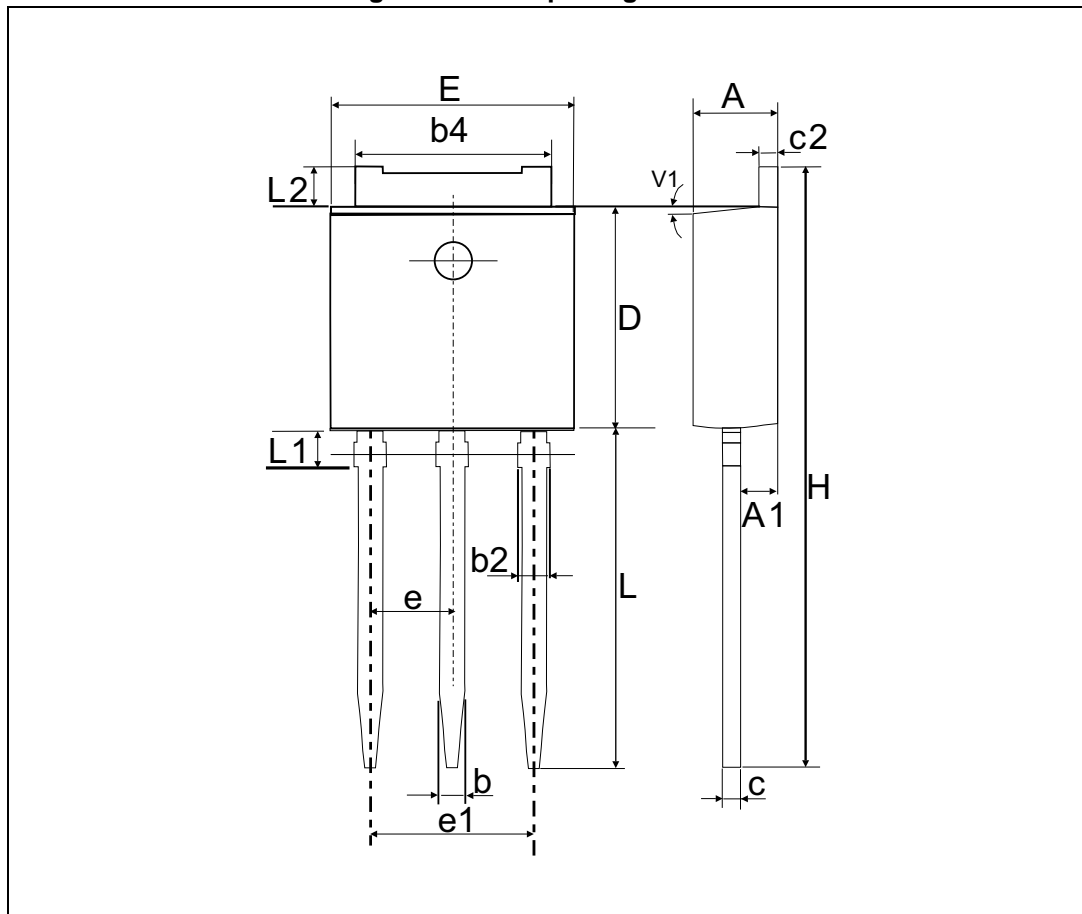
1. Inch dimensions are only for reference

Figure 13. Footprint (dimensions in mm)



## 2.2 IPAK package information

Figure 14. IPAK package outline



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



Table 8. IPAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.20		2.40	0.0866		0.0945
A1	0.90		1.10	0.0354		0.0433
b	0.64		0.90	0.0252		0.0354
b2			0.95			0.0374
b4	5.20		5.43	0.2047		0.2138
c	0.45		0.60	0.0177		0.0236
c2	0.46		0.60	0.0181		0.0236
D	6		6.20	0.2362		0.2441
E	6.40		6.65	0.2520		0.2618
e		2.28			0.0898	
e1	4.40		4.60	0.1732		0.1811
H		16.10			0.6339	
L	9		9.60	0.3543		0.3780
L1	0.8		1.20	0.0315		0.0472
L2		0.80	1.25		0.0315	0.0492
V1		10°			10°	

1. Inch dimensions are only for reference

### 2.3 TO-220AB (insulated and non-insulated) information

Figure 15. TO-220AB (insulated and non-insulated) package outline



Table 9. TO-220AB (insulated and non-insulated) package mechanical data

Ref.	Dimensions					
	Millimeters			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.5984		0.6259
a1		3.75			0.1476	
a2	13.00		14.00	0.5118		0.5511
B	10.00		10.40	0.3937		0.4094
b1	0.61		0.88	0.0240		0.0346
b2	1.23		1.32	0.0484		0.0519
C	4.40		4.60	0.1732		0.1811
c1	0.49		0.70	0.0192		0.0275
c2	2.40		2.72	0.0944		0.1070
e	2.40		2.70	0.0944		0.1062
F	6.20		6.60	0.2440		0.2598
ØI	3.73		3.88	0.1468		0.1527
I4	15.80	16.40	16.80	0.6220	0.6456	0.6614
L	2.65		2.95	0.1043		0.1161
I2	1.14		1.70	0.0448		0.0669
I3	1.14		1.70	0.0448		0.0669
M		2.60			0.1023	

1. Inch dimensions are only for reference

### 3 Ordering information

Figure 16. Order information scheme



Table 10. Product selector

Part number	Voltage (xxx)			Sensitivity	Type	Package
	600 V	700 V	800 V			
T405-xxxB	X			5 mA	Logic level	DPAK
T405-xxxB-TR	X	X	X	5 mA	Logic level	DPAK
T405-xxxH	X		X	5 mA	Logic level	IPAK
T405-xxxT	X			5 mA	Logic level	TO-220AB
T410-xxxB	X			10 mA	Logic level	DPAK
T410-xxxB-TR	X		X	10 mA	Logic level	DPAK
T410-xxxH	X		X	10 mA	Logic level	IPAK
T410-xxxT	X	X	X	10 mA	Logic level	TO-220AB
T435-xxxB	X			35 mA	Snubberless	DPAK
T435-xxxB-TR	X	X	X	35 mA	Snubberless	DPAK
T435-xxxH	X		X	35 mA	Snubberless	IPAK
T435-xxxT	X		X	35 mA	Snubberless	TO-220AB

Blank = Unavailable

Table 11. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode		
T405-600B	T4 0560	DPAK	0.3 g	75	Tube		
T410-600B	T4 1060						
T435-600B	T4 3560						
T405-600B-TR	T4 0560			2500	Tape and reel		
T410-600B-TR	T4 1060						
T435-600B-TR	T4 3560						
T405-700B-TR	T4 0570						
T435-700B-TR	T4 3570						
T405-800B-TR	T4 0580						
T410-800B-TR	T4 1080			IPAK	0.4 g	75	Tube
T435-800B-TR	T4 3580						
T405-600H	T4 0560						
T410-600H	T4 1060						
T435-600H	T4 3560						
T405-800H	T4 0580						
T410-800H	T4 1080	TO-220AB	2.3 g	50	Tube		
T435-800H	T4 3580						
T405-600T	T405-600T						
T410-600T	T410-600T						
T435-600T	T435-600T						
T410-700T	T410-700T						
T410-800T	T410-800T						
T435-800T	T435-800T						

## 4 Revision history

**Table 12. Document revision history**

Date	Revision	Changes
Jun-2003	2	Last updated.
25-Mar-2005	3	Layout updated, No content change.
25-Jan-2006	4	Markings changed in <i>Table 12</i> .
14-May-2014	5	Updated DPAK and IPAK package information and reformatted to current standard.
11-Feb-2015	6	Updated package silhouettes in cover page.
1-Apr-2016	7	Removed ISOWATT-220AB package information.
05-Oct-2016	8	Updated <i>Table 3</i> and <i>Table 11</i> . Updated <i>Figure 2</i> and <i>Figure 4</i> .
14-Nov-2016	9	Updated <i>Table 1</i> .

**IMPORTANT NOTICE – PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics – All rights reserved

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)  
Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)